



REV	MODIFICATION	DATE	DRAW
B	EN-04-0419	04.14.04"	Aaron

NOTES:

- Material :
Housing : Thermoplastic UL94V-0 .
Contact : Copper Alloy.
- Plating :
Contact Plating - 30u" Gold over 45u" MIN.Nickel
Solder Tail Plating - Gold Flash over 45u" MIN.Nickel
- Contact Forces :
Min. 1.00 N For 0.60mm Contact Deflection.
- Order Information :
SIMMS-006XXBXX2
30 : GOLD PLATING 30u".
0 : TAP REEL.
1 : TUBE.
0 : TIN/LEAD PLATING
T : LEAD FREE

DIMENSION IN mm [Inch]		PROD. SPEC.	ALMITA CO., LTD.	
TOLERANCE UNLESS OTHERWISE SPECIFIED		SP0051	Subscriber Identify Module Card Simple Style Conn. H=2.0mm	
.X±0.30	X.*± 1'	PKG. SPEC.	CUSTOMER DRAWING	
.XX±0.20	.X.*± 0.5'	PPP-SIM-004		
.XXX±0.10	.XX.*± 0.25'	APPROVE		
		CHECK	FILE NO. KFP-051	DWG NO. SIMMS-006XXBXX2
		DRAW	SIZE A4	PROJ. SHEET 1 / 1
			SCALE 4:1	REV B